

Reliability of Wearable Electronics

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What is Reliability?

- Reliability is the measure of a product's ability to
 - ...perform the specified function
 - ...at the customer (with their use environment)
 - ...over the desired lifetime

- To ensure reliability, we have to think about
 - What is the product supposed to do?
 - Where is going to be used?
 - o How long should it last?



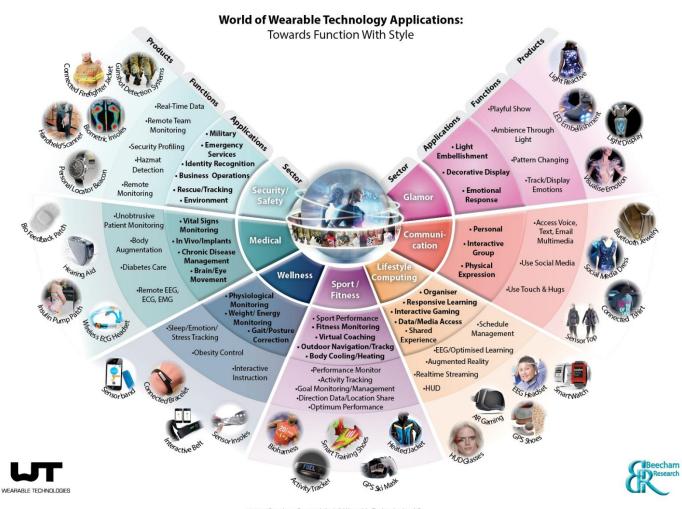
What are Wearable Electronics?

- Wikipedia: "...miniature electronic devices that are worn by the bearer under, with or on top of clothing."
 - o That's It?!

Alternative Definition

 Technology attached to the human body or clothing that allows the wearer to monitor, engage with, and control devices, themselves, or their social network

What are Wearable Electronics (cont.)



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Wearable Electronics Use Next

Generation Technology

- What is 'Next Generation' Technology?
 - Materials or designs currently being used, but not widely adopted (especially among hi reliability manufacturers)



- Carbon nanotubes are not 'Next Generation'
 - Not used in electronic applications
- Ball grid array (BGA) is not 'Next Generation'
 - Widely adopted





Next Generation Technology (cont.)

Why is knowing about 'Next
 Generation' Technologies important?

- These are the technologies that you or your supply chain will use to improve your product
 - Cheaper, Faster, Stronger, 'Environmentally-Friendly', etc.

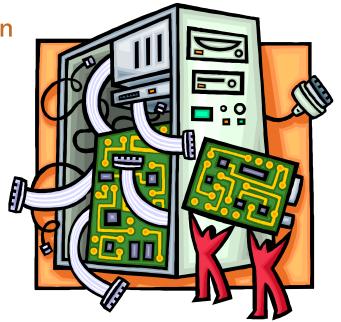


However...



Reliability and Next Gen Technologies

- One of the most common drivers for failure is inappropriate adoption of new technologies
 - The path from consumer (high volume, short lifetime) to high rel is not always clear
- Obtaining relevant information can be difficult
 - Information is often segmented
 - Focus on opportunity, not risks
- Sources are either marketing mush or confusing, scientific studies
 - Where is the practical advice?



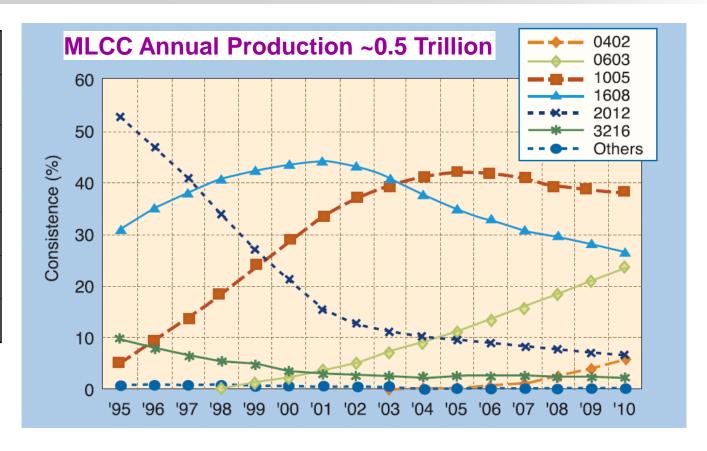
NextGen Technologies: The Reality

- Market studies and mobile phone markets can skew reality of market adoption
 - Annual sales of >100 million may be due to one or two customers
- Mobile phone requirements may not match the needs of wearable electronics
- Market studies exclusively focused on volume
 - More relevant may be number of customers
- Example: 0201 capacitors



"The Smaller the Better" - 0201 Ceramic Capacitors

Metric	English
0402	01005
0603	0201
1005	0402
1608	0603
2012	0805
3216	1206



 Based on volume, 0201 capacitors were 25% of the multilayer ceramic capacitor (MLCC) market in 2010



0201 Ceramic Capacitors: The Reality

- Actual high usage applications
 - Ultra small modules (primarily hearing aids) / high frequency
- Major users were limited to approximately 8 to 10 high volume companies in very benign environments and very limited lifetimes
- Attempts to integrate 0201 capacitor technology into more demanding applications, such as medical implants, resulted in quality issues, unexpected degradation, and major warranty returns



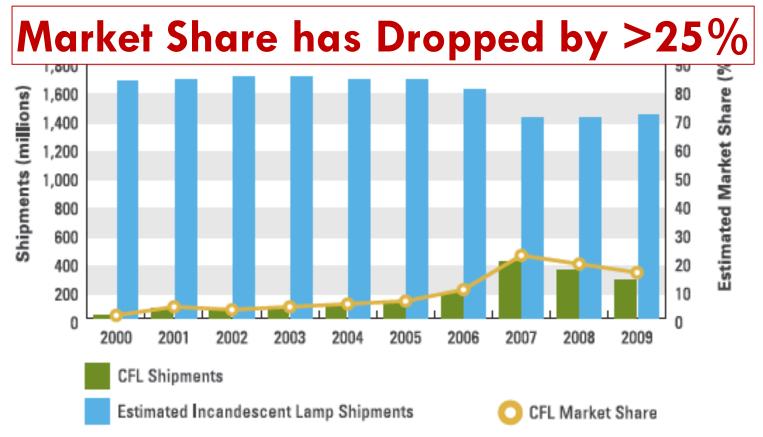
Examples of Next Gen Technologies in Wearables

- Embedded components
- Ultra-small components (i.e., 01005 capacitors)
- New substrate materials
 - Polyethersulfone, polyethylene terephthalate (PET), polyethylene napthalate (PEN)
 - Polyimide is <u>not</u> a next gen technology
- Printed connections
 - Silver inks, copper inks, nanosolders, conductive polymers
- Organic displays
- Power Via Supercapacitors



Why Care About Reliability? A Warning Lesson for Wearables

- "Durability"
- Case Study: Compact Fluorescent Lamps (CFLs)



CFL Market Profile: Data Trends and Market Insights, US Dept. of Energy, September 2010



CFL Reliability: Perception and Reality

- Prof. Siminovitch of UC –
 Davis has identified three
 (3) areas of dissatisfaction
 - Color quality
 - Dimming
 - Product longevity
- Numerous other websites
 / blogs have reported
 issues with CFL reliability

green.blogs.nytimes.com/2009/01/27/why-efficient-light-bulbs-fail-to-thrive/, Jan. 27, 2009, New York Times

- Rensselaer Polytechnic Institute (RPI) found early failure rates of CFLs between 2 to 13 percent
 - Returns higher in thermally challenging environments (reflectors, high switching)
 - Indications that power supplies play a major role in failures

Will LED Light Bulbs Best Your CFLs and Incandescents?, Popular Mechanics, August 4, 2010, http://www.popularmechanics.com/science/environme nt/will-led-light-bulbs-best-cfls-and-incandescents



Ensuring Wearable Electronics Reliability

- DfR at Concept / Block-Diagram Stage
 - Specifications
- Part Selection
 - Derating and uprating
- Design for Manufacturability
 - Reliability is only as good as what you make
- Wearout Mechanisms and Physics of Failure
 - Predicting degradation in today's electronics



Specifications

 Two key specifications important to capture at concept/contract stage that influence reliability

Reliability expectations

Use environment



Reliability Goals

- Identify and document two metrics
 - Desired lifetime
 - Product performance

Desired lifetime

- Defined as when the customer will be satisfied
- Should be actively used in development of part and product qualification

Product performance

- Returns during the warranty period
- Survivability over lifetime at a set confidence level
- MTBF or MTTF calculation should be primarily an administrative or marketing exercise (response to customer demands)



Desired Lifetime and Wearable

Electronics

- What is the desired lifetime of wearable electronics?
- Rough equivalents: Clothes, shoes, watches, glasses, cell phones
 - Clothes: ??
 - Shoes: 3 months to 5 years (600 miles)
 - Watches: 3 to 20 years
 - Glasses: 2 to 5 years
 - Cell phones: 12 to 36 months
- With a new technology, there is an opportunity to influence expectations



Product Performance: Warranty Returns

Consumer Electronics

- 。 5-25%
- Low Volume, Non Hi-Rel
 - 。 1 to 2%

Industrial Controls

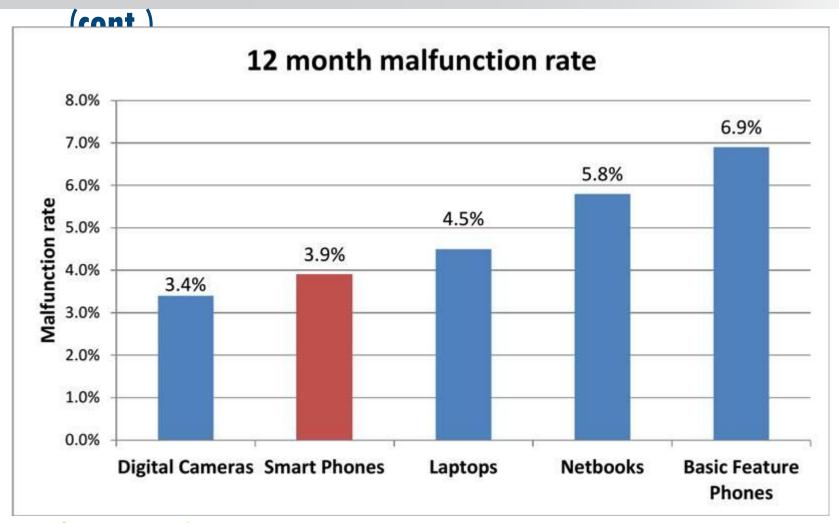
- 500 to 2000 ppm (1st Year)
- Depends on complexity, production volumes, and risk sensitivity

Automotive

- 1 to 5% (Electrical, 1st Year)
- Can also be reported as problems per 100 vehicles



Product Performance: Warranty Returns



Square Trade



Product Performance: Class III Medical

Family	Cumulative Failures	Duration (yrs)	Lifetime (yrs)	Units	Therapy Comprised	Therapy Uncomprised	Probability Device-Year (Hazard)
SecuraDR	0.0%	1	10	14000	0	0	0.00%
SecuraVR	0.0%	1	10	6000	0	0	0.00%
Maximo DR	0.1%	6	8	37000	8	26	0.02%
VirtuosoDR	0.1%	4	10	71000	19	15	0.03%
GEM III VR	0.3%	10	10	17000	9	27	0.03%
Intrinsic	0.2%	6	10	31000	7	36	0.03%
Maximo VR	0.2%	6	10	43000	12	33	0.03%
VirtuosoVR	0.1%	3	10	32000	9	4	0.03%
GEM III DR	0.3%	7	7	20000	11	27	0.04%
Marquis VR	0.4%	7	10	19000	15	27	0.06%
EntrustDR	0.3%	5	10	28000	6	37	0.06%
EntrustVR	0.3%	5	10	14000	5	21	0.06%
Marquis DR	0.8%	7	7	48000	100	79	0.11%
Onyx	0.5%	5	10	1000	1	3	0.10%
GEM	1.0%	10	10	22000	N/A	N/A	0.10%
GEM DR	1.2%	10	10	15000	N/A	N/A	0.12%
EntrustDR	2.8%	5	10	500	1	6	0.56%
VirtuosoDR (advisory)	28.3%	4	10	4000	2	490	7.08%



Product Performance: Survivability

- Some companies set reliability goals based on survivability
 - Often bounded by confidence levels
 - Example: 95% reliability with 90% confidence over 15 years

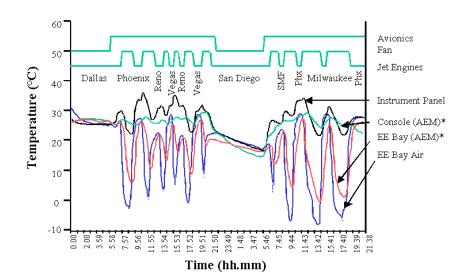
Advantages

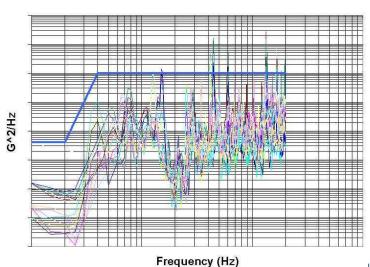
- Helps set bounds on test time and sample size
- Does not assume a failure rate behavior (decreasing, increasing, steady-state)

Identify and Quantify Failure Inducing

Loads

- Temperature Cycling
 - Tmax, Tmin, dwell, ramp times
- Sustained Temperature
 - T and exposure time
- Humidity
 - Controlled, condensation
- Corrosion
 - Salt, corrosive gases (CI2, etc.), UV
- Power cycling
 - Duty cycles, power dissipation
- Electrical Loads
 - Voltage, current, current density
 - Static and transient
 - Electrical Noise
- Mechanical Bending (Static and Cyclic)
 - Board-level strain
- Random Vibration
 - PSD, exposure time, kurtosis
- Harmonic Vibration
 - G and frequency
- Mechanical shock
 - o G, wave form, # of events



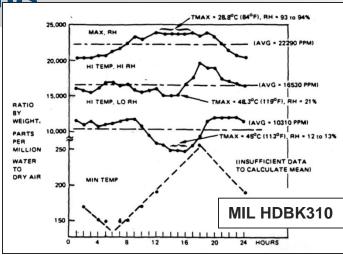


Identify Environment: Standards

 Usually, the first approach is to use standards

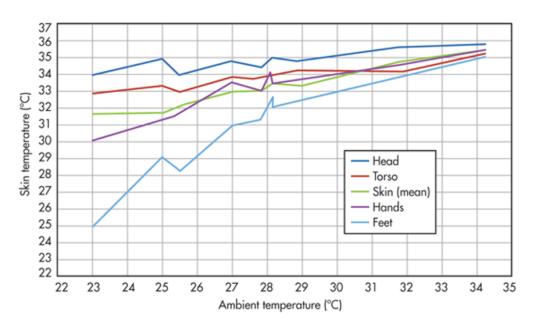
 However, existing standards do not work well with wearable electronics

 More geared towards permanent installations



	WORST-CASE USE ENVIRONMENT					ACCELERATED TESTING			NG		
USE CATEGORY	Tmin °C	Tmax °C	ΔT ⁽¹⁾ °C	t _D hrs	Cycles/ year	Typical Years of Service	Approx. Accept. Failure Risk, %	Tmin °C	Tmax °C	ΔT ⁽²⁾ °C	t _D min
1) CONSUMER	0	+60	35	12	365	1-3	1	+25	+100	75	15
2) COMPUTERS	+15	+60	20	2	1460	5	0.1	+25	+100	75	15
3) TELECOM	- 40	+85	35	12	365	7-20	0.01	0	+100	100	15
4) COMMERCIAL AIRCRAFT	-55	+95	20	12	365	20	0.001	0	+100	100	15
5) INDUSTRIAL & AUTOMOTIVE PASSENGER COMPARTMENT	-55	+95	20 &40 &60 &80	12 12 12 12	185 100 60 20	10	0.1	0	+100	100	15
										& COLD(3	
6) MILITARY GROUND & SHIP	-55	+95	40 &60	12 12	100 265	10	0.1	0	+100	100 & COLD ⁽³⁾	15
71.004.05					0700		0.004				
7) SPACE leo geo	-55	+95	3 to 100	1 12	8760 365	5-30	0.001	0	+100	100 & COLD ⁽³⁾	15
8) MILITARY AVIONICS a b c	-55	+95	40 60 80 &20	2 2 2 1	365 365 365 365	10	0.01	0	+100	100 & COLD ⁽³⁾	15
9) AUTOMOTIVE UNDER HOOD	-55	+125	60 &100 &140	1 1 2	1000 300 40	5	0.1	0	+100	100	15
									IDC	CM	70 <i>E</i>

Field Environment: Temperature



- Maximum
 temperatures likely
 not a significant
 concern
- Typically far below ratings

- However, very cold temperatures (below -20C) could be a challenge
 - Especially in combination with a mechanical load

Temperature	Avg. U.S. CLIM Data	Avg. U.S. Weighted by Registration (Source: Confidential)	Phoenix (hrs/yr)	U.S. Worst Case (hrs/yr)
95F (35C)	0.375%	0.650%	11% (948)	13% (1,140)
105F (40.46C)	0.087%	0.050%	2.3% (198)	3.8% (331)
115F (46.11C)	0.008%	0.001%	0.02% (1.4)	0.1% (9)



Field Environment: Mechanical

Vibration

- Not typically affiliated with human body, but outliers can occur (especially with tools, transportation)
- Examples: Jackhammer, reciprocating saw
- Have induced failures in rigid medical devices

Mechanical Shock

- Drop loads can reach
 1500g for mobile phone
 (some OEMs evaluate up to 10,000g)
- Likely to be lower for lighter wearables, but could be repeated (i.e., affiliated with shoes)

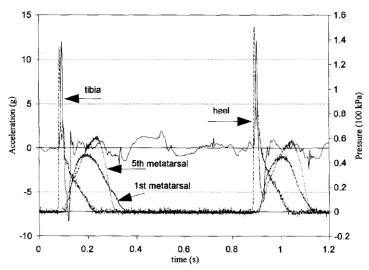


Fig. 7. Typical acceleration and pressure patterns recorded while subject was running.



Field Environment: Mechanical (cont.)

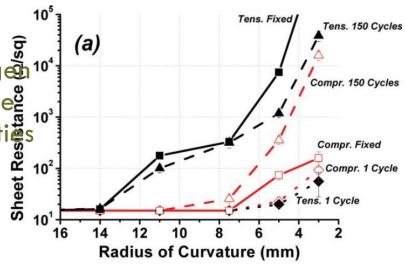
Bending (Cyclic / Overstress)

- Often considered one of the biggest risks in regards to wearables
- Certain human movements that induce bending (flexing of the knee) can occur over 1,000/day

Case Study

- There is indication that next-gen substrate materials experience a change in electrical properties after exposure to bending

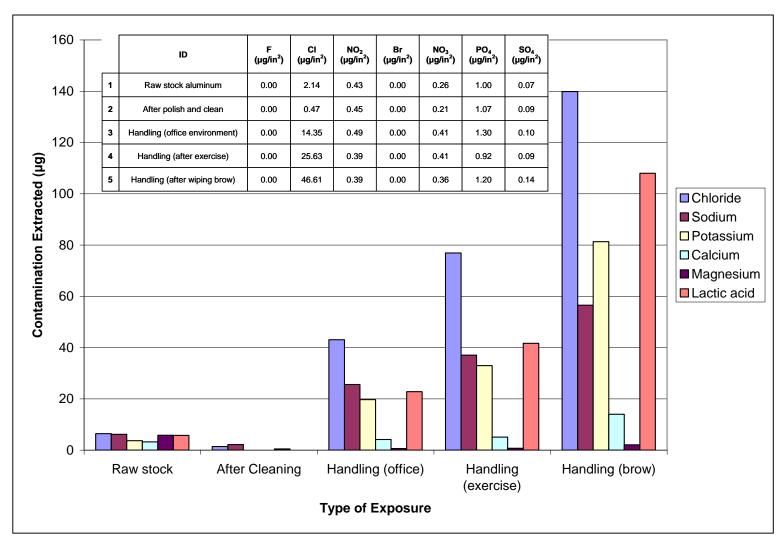
 Can be exacerbated by
- Can be exacerbated by elevated temperature



Corrosion: Handling / Sweat

- Composition of dissolved salts in water
 - Can include other biological molecules.
- Main constituents, after the solvent (water),
 - o Chloride, sodium, potassium, calcium, magnesium, lactate, and urea.
- Chloride and sodium dominate.
 - To a lesser but highly variable extent, iron, copper, urocanate (and the parent molecule histidine), and other metals, proteins, and enzymes are also present.
- The main concern regarding sweat is as a source of chloride
 DfR Solutions

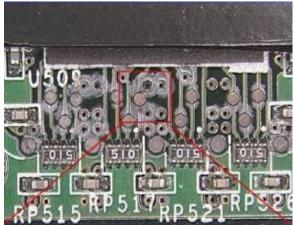
Handling / Sweat (cont.)

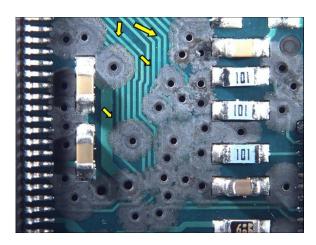


Influence of Pollutants: Creepage

Corrosion

- Recent field issues with printed circuit boards (PCBs) plated with immersion silver
 - Sulfur-based creepage corrosion
- Failures in customer locations with elevated levels of sulfur-based gases
 - Rubber manufacturing
 - Sewage/waste-water treatment plants
 - Vehicle exhaust fumes (exit / entrance_ramps)
 - Petroleum refineries
 - Coal-generation power plants
 - Paper mills
 - Landfills
 - Large-scale farms
 - Automotive modeling studios
 - Swamps
 - Fast Food Restaurants
 - "Silicone is being used because it is soft and smooth"



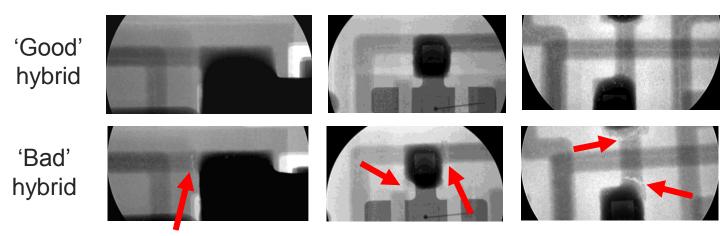


P. Mazurkiewicz, ISTFA 2006



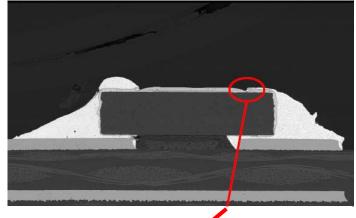
Sulfur Attack of Encapsulated Hybrid

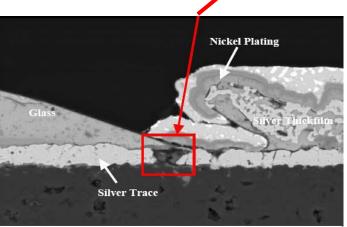
- Silicone encapsulant, ceramic hybrid
- Used in industrial controls
- Customer reported failures
 after a few months in the field
- X-ray identified several separations



SMT Resistors-Sulfidation from Sulfur Exposure

- Sulfur attack of silver occurs at the abutment of the glass passivation layer and the resistor termination
 - Cracks or openings can allow the ingress of corrosive gases,
 - Reaction with the silver to form silver sulfide (Ag2S)
- Large change in resistance
 - $_{\circ}$ $r_{Ag} = 10^{-8} \text{ ohm-m};$ $r_{Ag2S} = 10 \text{ ohm-m}$
 - Up 20K ohms (0.01 x 0.01 x 0.5mm)
- Manufacturers' solutions
 - Sulfur tolerant silver alloys
 - Sulfur resistant silver replacement







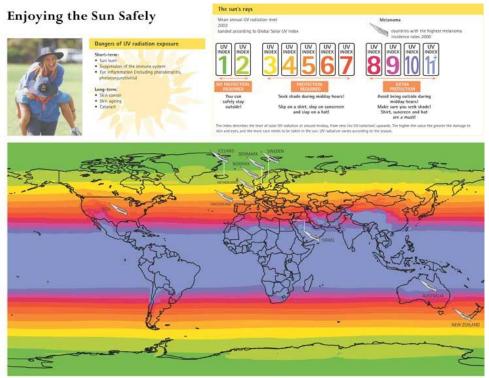
Corrosion: UV Exposure

- Exposure to ultraviolet (UV) is typically not sufficient to induce degradation in electronic materials
- However, a combination of temperature, moisture, and UV can induce scission in polymeric chains
 - Exact combination, and specific portion of the UV spectrum, is not always well characterized
- It has been documented that stress corrosion cracking has been caused by sun tan lotion



UV Exposure

Annual UV Intensity – Global Picture



Annual	UV Ene	ergy Calculation	ons by City
City	Latitude	Energy at 340nm	Average Annual Total Radiant Dose at 340nm (kJ/m^2/nm)
Singapore	1	426	' '
Paris, France	48	499	1796
Sao Paulo, Brazil	22	553	1991
Tokyo, Japan	35	570	2053
Guatemala	14	648	2334
Miami , FL	25	661	2380
New York NY	40	661	2381
Barcelona, Spain	41	662	2382
Brasilia, Brazil	15	662	2383
Melbourne, Australia	37	708	2549
Buenos Aires, Argentina	34	727	2618
Baghdad, Iraq	33		
Minneapolis, MN	44		
Townsville, Australia	19	743	2673
Madrid, Spain	40	748	2694
LA, CA	34	767	2761
Phoenix, AZ	33	869	3129

http://www.drb-mattech.co.uk/uv%20map.html

Of Cities listed, Phoenix has highest avg annual exposure. Note: Model is isolated to UV. Humidity is not included.



Other Challenging Environments for

Wearables

Washer / Dryer

Cleaning fluids

Mud / Dust / Water



Environment (Best Practice)

- Use standards when...
 - Certain aspects of your environment are common
 - No access to use environment

- Measure when...
 - Certain aspects of your environment are unique
 - Strong relationship with customer
- Do not mistake test specifications for the actual use environment
 - Common mistake with mechanical loads



How Have Wearable Consumer Electronics Failed?

Sweat

 It has been documented in blogs that Apple iPOD Nano's have shorted out due to sweat

Strain relief

 Wearable on clothing, attached by a cord to power device, failed prematurely due to a lack of strain relief

Plasticizer

 First-generation of Amazon Kindle wiring insulation cracked/crumbled due to the use of non-optimized plasticizer formulation

Cyclic Fatigue

 Initial video game controllers experienced fatigue of solder joints on components attached to the backside of the push buttons



Follow the Toyota Example (Case Study)

- <u>Traditional approach</u>: Design radiator for a specific vehicle based on mechanical specifications written for that vehicle
- Toyota considers a range of radiator solutions based on cooling capacities and the cooling demands of various engines that might be used.
 - How the radiator actually fits into a vehicle would be kept loose so that Toyota's knowledge of radiator technology could be used to create the optimum design
- Toyota's system is "test & design" rather than the traditional "design & test."
 - Toyota engineers test at the fundamental knowledge level so they don't have to test at the later, more expensive stages of design and prototyping



Conclusion

- Wearable electronics are an exciting revolution in our engagement with ourselves and the world around us
- However, there are clear risks
 - Wearables <u>will</u> be using new technology that has not been fully characterized
 - They will be placed in environments that are not fully considered by the designer
- There will be unexpected failures, resulting in delays in product launch and potential advisory notices, if wearable manufacturers do not use industry best practices and physics of failure to qualify their technology



Thanks!!

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